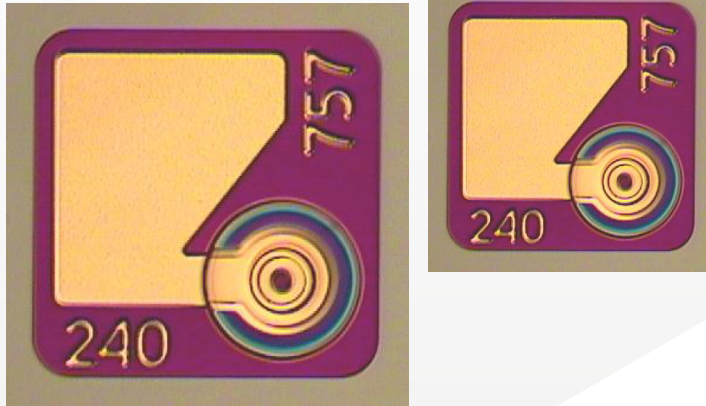


II-VI



APA8501010001

850nm Polarization Locked Single Mode VCSEL Chip

Features:

- Single transverse and longitudinal mode
- Polarization stable emission
- Low power consumption
- High reliability
- Gaussian beam profile
- Backside cathode and topside anode configuration
- RoHS compliant

850nm Polarization Locked Single Mode VCSEL Chip

Electro-Optical Characteristics

Operating conditions: $T_{op} = 5^\circ - 45^\circ\text{C}$; $I_{op} = \text{const.}$, set at 25°C so that $P_{op} = 0.55\text{mW}$

Parameter	Symbol	Ratings			Unit	Conditions
		Min	Typ	Max		
Threshold Current	I_{th}	1	3	5	mA	$T = 25^\circ\text{C}$
Slope Efficiency	η	0.20	0.40	0.65	mW/mA	$T = 25^\circ\text{C}$, $I = I_{th} + 1\text{mA}$
Operating Current	I_{op}	2.3		6	mA	$T = 25^\circ\text{C}$, $P_{op} = 0.55\text{mW}$
Operating Voltage	U_{op}			2.3	V	Operating conditions
Differential Resistance	R_d	20		90	Ω	$T = 25^\circ\text{C}$, $P_{op} = 0.55\text{mW}$
SM Optical Output Power	P_{SM}	0.9			mW	$T = 25^\circ\text{C}$
Side Mode Suppression Ratio	SMSR	10			dB	$T = 25^\circ\text{C}$, $P_{op} = 0.9\text{mW}$
Accuracy of Polarization Direction *	δ_{pol}	-15		+15	deg	$T = 25^\circ\text{C}$, $P_{op} = 0.2 \dots 0.9\text{mW}$
Emission Wavelength	λ_{peak}	840	850	860	nm	Operating conditions
Beam Divergence	$\theta_{FW1/e2}$	13	17	21	deg	$T = 25^\circ\text{C}$, $P_{op} = 0.5\text{mW}$
Optical power variation over temperature	$P(T) - P_{op}$	-200		+120	μW	I_{op} , $T = 5 \dots 45^\circ\text{C}$

SM= single mode; $FW1/e2$ = full width $1/e^2$

* Polarization direction relative to the chip: see chip layout in section "Chip Dimensions"

Absolute Maximum Ratings

Parameter	Max Rating	Unit	Condition
Continuous Operating Current	8	mA	
Continuous Reverse Voltage	8	V	
PCB solder or reflow temperature	260	$^\circ\text{C}$	max 10 seconds

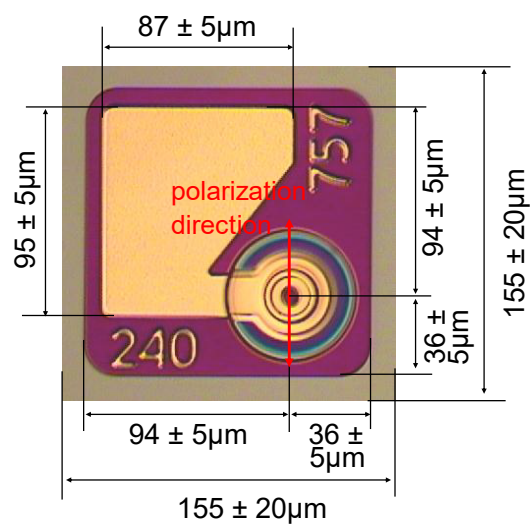
850nm Polarization Locked Single Mode VCSEL Chip

Packaging and Supply

- Sawn wafer on adhesive tape
- Wafer map files describing positions of good dice

Chip Dimensions

Parameter	Min	Typ	Max	Unit
Chip width	135	155	175	μm
Chip length	135	155	175	μm
Chip thickness	135	150	165	μm



Chip thickness: $150 \pm 15 \mu\text{m}$

850nm Polarization Locked Single Mode VCSEL Chip

RoHS Compliance

II-VI is fully committed to environment protection and sustainable development and has set in place a comprehensive program for removing polluting and hazardous substances from all of its products. The relevant evidence of RoHS compliance is held as part of our controlled documentation for each of our compliant products. RoHS compliance parts are available to order, please refer to the ordering information section for further details.

Ordering Information

Product Code	Description
APA8501010001	850nm Polarization Locked SM VCSEL Chip

Important Notice

Performance figures, data and any illustrative material provided in this data sheet are typical and must be specifically confirmed in writing by II-VI before they become applicable to any particular order or contract. In accordance with the II-VI policy of continuous improvement specifications may change without notice. Further details are available from any II-VI sales representative.

Safety Labels



Caution - use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.